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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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09792909-5360

SERIAL NO. Not yet assigned

GROUP ART UNIT: Not yet assigned

FILED:

February 8, 2002

EXAMINER:

Not yet assigned

TITLE: "METHOD TO MANUFACTURE LEAD-FREE SOLDER MATERIAL HAVING GOOD WETTABILITY" (as amended)

PRELIMINARY AMENDMENT "A" TO DIVISIONAL

BOX Patent Application Assistant Commissioner for Patents Washington, D.C. 20231

SIR:

This is a preliminary amendment to the 37 CFR 1.53(b) Divisional filed on

February 8, 2002.

IN THE TITLE

Please amend the title of the invention to read -- METHOD TO MANUFACTURE LEAD-FREE SOLDER MATERIAL HAVING GOOD WETTABILITY--.

IN THE SPECIFICATION

On page 1, between lines 2 and 3, please insert the following paragraph:

---RELATED APPLICATION DATA

This application claims priority to Japanese Application No. P09-348212, filed December 17, 1997, and is a divisional of United States Application Serial No. 09/066,851, filed April 28, 1998, each of which is incorporated herein by reference to the extent permitted by law.--

IN THE CLAIMS

Please cancel claims 1-4 in favor of new claims 5-44. Please add new claims 5-44 as

15 follows: